STTA2512P
STTA5012TV1/2

TURBOSWITCH ™ ULTRA-FAST HIGH VOLTAGE DIODE

MAIN PRODUCT CHARACTERISTICS

$I_{F(AV)}$	25A
V_{RRM}	1200V
t_{rr} (typ)	60ns
V_F (max)	1.9V

FEATURES AND BENEFITS

■ ULTRA-FAST, SOFT RECOVERY.

■ VERY LOW OVERALL POWER LOSSES IN BOTH THE DIODE AND THE COMPANION TRANSISTOR.

■ HIGH FREQUENCY AND/OR HIGH PULSED CURRENT OPERATION.

■ HIGH REVERSE VOLTAGE CAPABILITY.

■ LOW INDUCTANCE PACKAGE < 5 nH.

■ INSULATED PACKAGE : ISOTOP^{TM}
   Electrical insulation : 2500V$_{RMS}$
   Capacitance : < 45pF.

STTA5012TV1   STTA5012TV2

ISOTOP^{TM}

SOD93
STTA2512P
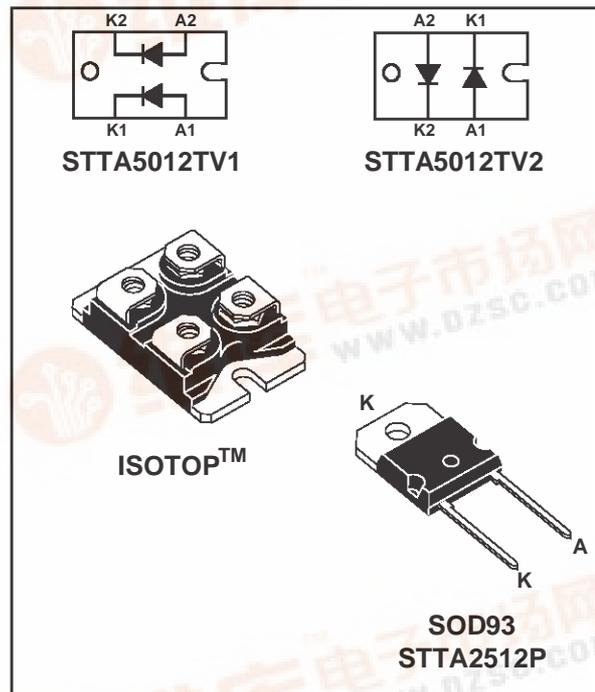
DESCRIPTION

TURBOSWITCH 1200V drastically cuts losses in all high voltage operations which require extremely fast, soft and noise-free power diodes. Due to their optimized switching performances they also highly decrease power losses in any associated switching IGBT or MOSFET in all freewheel mode operations.

They are particularly suitable in Motor Control circuitries, or in the primary of SMPS as snubber, clamping or demagnetizing diodes. They are also suitable for secondary of SMPS as high voltage rectifier diodes.

ABSOLUTE RATINGS (limiting values, per diode)

Symbol	Parameter		Value	Unit
V_{RRM}	Repetitive peak reverse voltage		1200	V
$I_{F(RMS)}$	RMS forward current		50	A
I_{FRM}	Repetitive peak forward current	tp = 5 µs F = 5kHz square	300	A
I_{FSM}	Surge non repetitive forward current	tp = 10ms sinusoidal	210	A
T_{stg}	Storage temperature range		- 65 to + 150	℃
T_j	Maximum operating junction temperature		150	℃

THERMAL AND POWER DATA (per diode)

Symbol	Parameter	Conditions		Value	Unit
$R_{th(j-c)}$	Junction to case thermal resistance	ISOTOP	Per diode	1.4	°C/W
		ISOTOP	Total	0.75	
		SOD93		1.2	
$R_{th(c)}$	Coupling thermal resistance	ISOTOP	Coupling	0.1	°C/W
P_1	Conduction power dissipation $I_{F(AV)} = 25A$ $\delta = 0.5$	ISOTOP	Tc= 70°C	57	W
		SOD93	Tc= 82°C		
P_{max}	Total power dissipation Pmax = P1 + P3 (P3 = 10% P1)	ISOTOP	Tc= 62°C	62.5	W
		SOD93	Tc= 75°C		

STATIC ELECTRICAL CHARACTERISTICS (per diode)

Symbol	Parameter	Test conditions		Min	Typ	Max	Unit
V_F *	Forward voltage drop	$I_F = 25A$	Tj = 25°C			2.1	V
			Tj = 125°C		1.3	1.9	V
I_R **	Reverse leakage current	$V_R = 0.8 \times V_{RRM}$	Tj = 25°C			150	µA
			Tj = 125°C		2.0	8	mA
V_{to}	Threshold voltage	$Ip < 3.I_{F(AV)}$	Tj = 125°C			1.52	V
R_d	Dynamic resistance					15	mΩ

Test pulses :   * tp = 380 µs, δ < 2%
                 ** tp = 5 ms , δ < 2%

To evaluate the maximum conduction losses use the following equation :
$P = V_{to} \times I_{F(AV)} + Rd \times I_F^2{}_{(RMS)}$

DYNAMIC ELECTRICAL CHARACTERISTICS (per diode)

TURN-OFF SWITCHING

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
t_{rr}	Reverse recovery time	Tj = 25°C $I_F = 0.5 A$ $I_R = 1A$ Irr = 0.25A $I_F = 1 A$ $dI_F/dt = -50A/\mu s$ $V_R = 30V$		60	110	ns
I_{RM}	Maximum reverse recovery current	Tj = 125°C VR = 600V $I_F = 25A$ $dI_F/dt = -200 A/\mu s$ $dI_F/dt = -500 A/\mu s$		45	35	A
S factor	Softness factor	Tj = 125°C $V_R = 600V$ $I_F = 25A$ $dI_F/dt = -500 A/\mu s$		1.2		/

TURN-ON SWITCHING

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
t_{fr}	Forward recovery time	Tj = 25°C $I_F = 25 A$, $dI_F/dt = 200 A/\mu s$ measured at $1.1 \times V_F$max			900	ns
V_{Fp}	Peak forward voltage	Tj = 25°C $I_F = 25A$, $dI_F/dt = 200 A/\mu s$ $I_F = 40A$, $dI_F/dt = 500 A/\mu s$		35	30	V

STTA2512P / STTA5012TV1/2

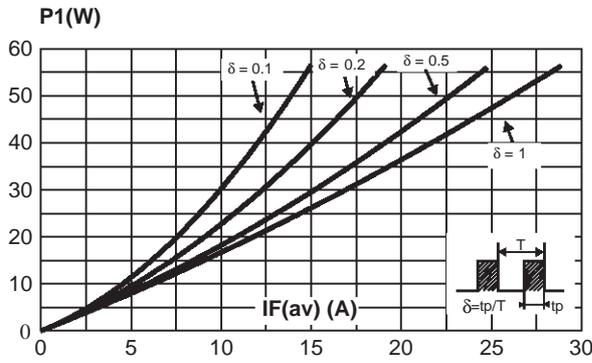**Fig. 1:** Conduction losses versus average current (per diode).

Fig. 2: Forward voltage drop versus forward current (maximum values, per diode).
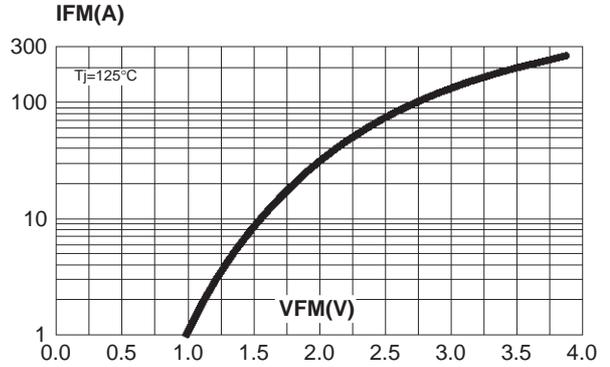

Fig. 3-1: Relative variation of thermal impedance junction to case versus pulse duration (per diode) (ISOTOP).
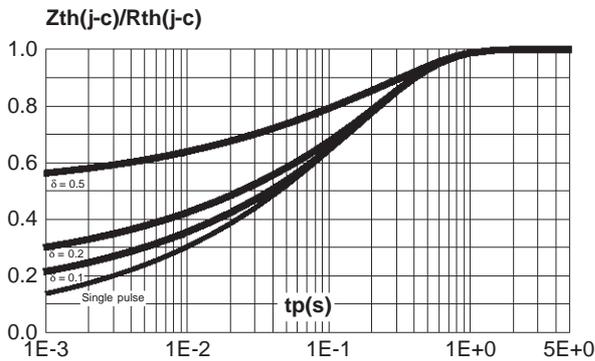

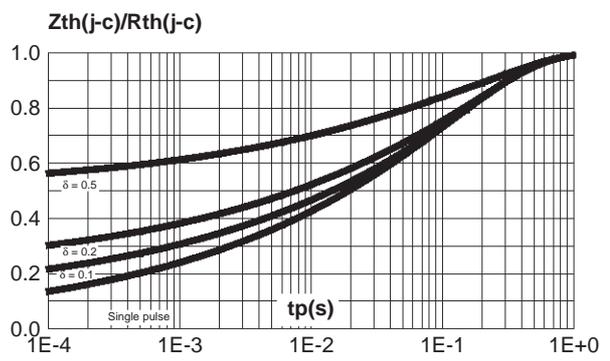**Fig. 3-2:** Relative variation of thermal impedance junction to case versus pulse duration (SOD93).

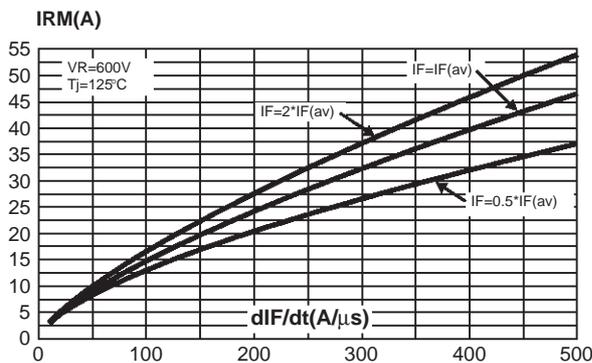**Fig. 4:** Peak reverse recovery current versus dI_F/dt (90% confidence, per diode).

Fig. 5: Reverse recovery time versus dI_F/dt (90% confidence, per diode).
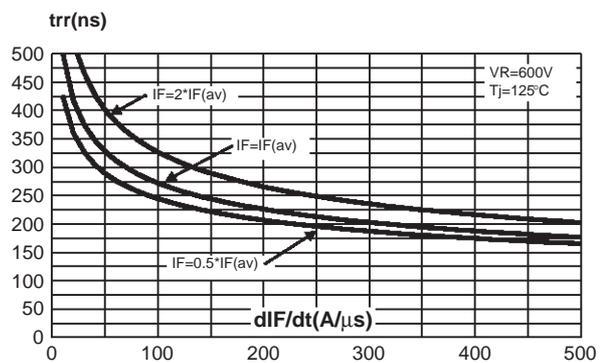
Fig. 6: Softness factor (tb/ta) versus dI$_F$/dt (typical values, per diode).

S factor
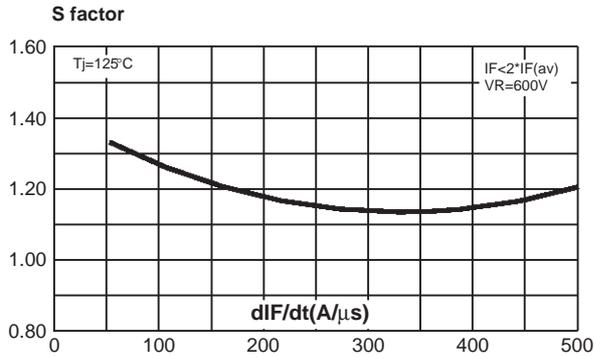
Fig. 7: Relative variation of dynamic parameters versus junction temperature (reference Tj=125°C).
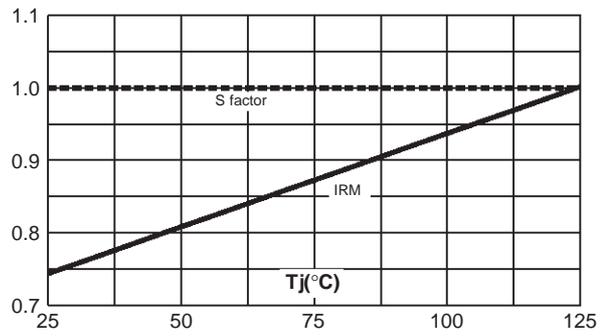
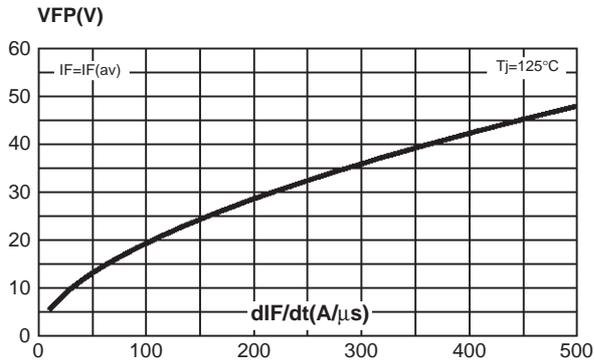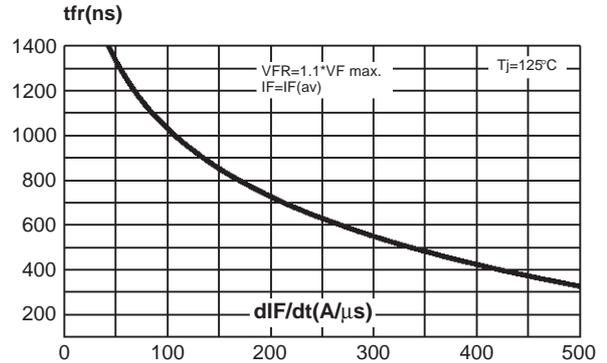**Fig. 8:** Transient peak forward voltage versus dI$_F$/dt (90% confidence, per diode).

VFP(V)

Fig. 9: Forward recovery time versus dI$_F$/dt (90% confidence, per diode).

tfr(ns)

APPLICATION DATA

The 1200V TURBOSWITCH series has been designed to provide the lowest overall power losses in all high frequency or high pulsed current operations. In such applications (Fig A to D),the way of calculating the power losses is given below :
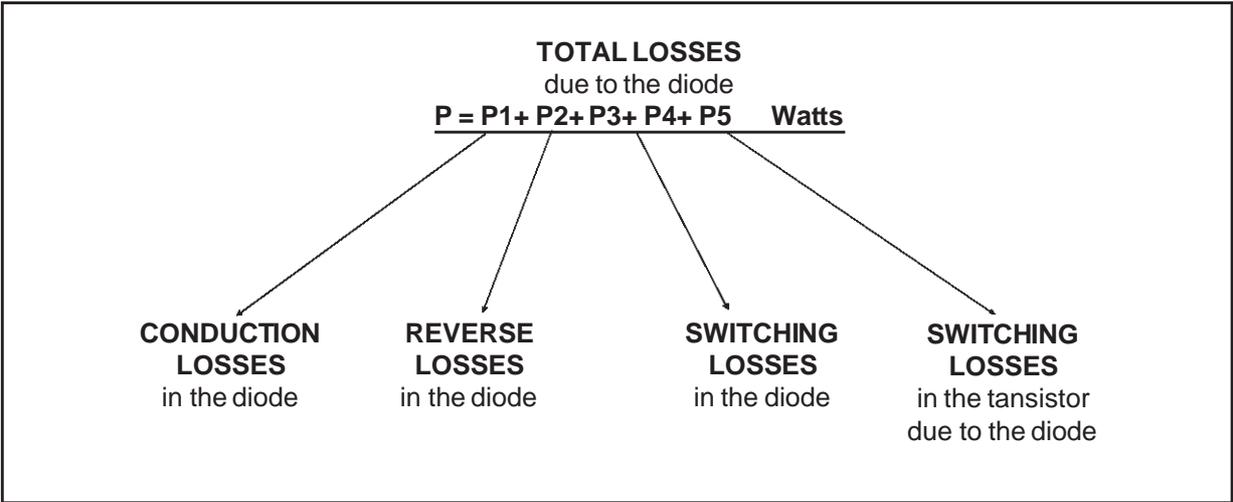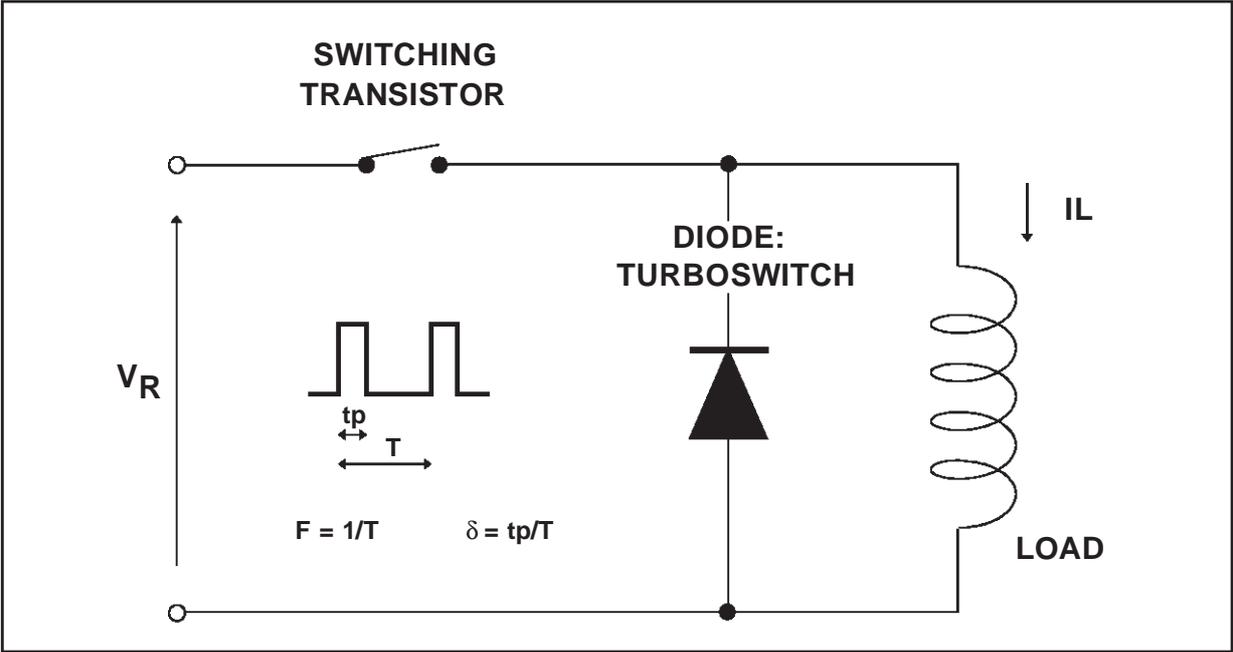
TOTAL LOSSES
due to the diode
P = P1+ P2+ P3+ P4+ P5   Watts

| **CONDUCTION LOSSES** in the diode | **REVERSE LOSSES** in the diode | **SWITCHING LOSSES** in the diode | **SWITCHING LOSSES** in the tansistor due to the diode |

Fig. A : "FREEWHEEL" MODE.

SWITCHING TRANSISTOR

V_R

tp

T

DIODE: TURBOSWITCH
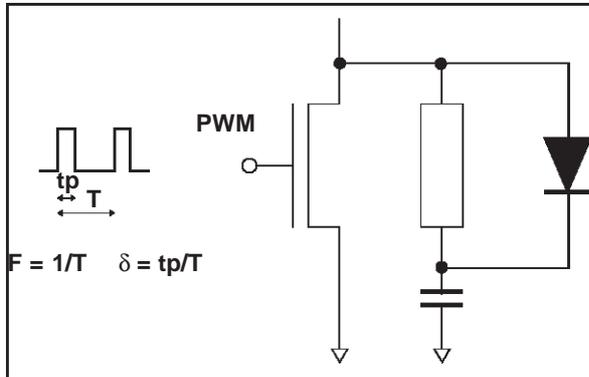
IL

LOAD

F = 1/T $\delta = tp/T$

Fig. B : SNUBBER DIODE.

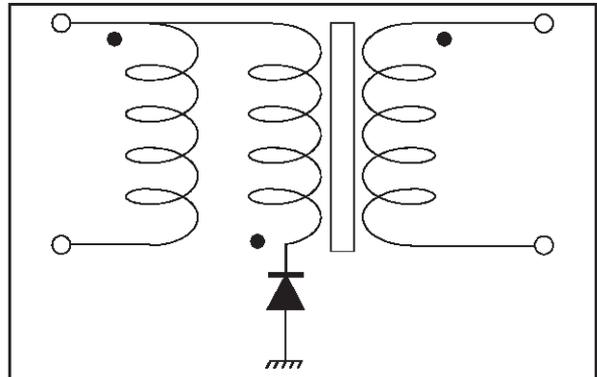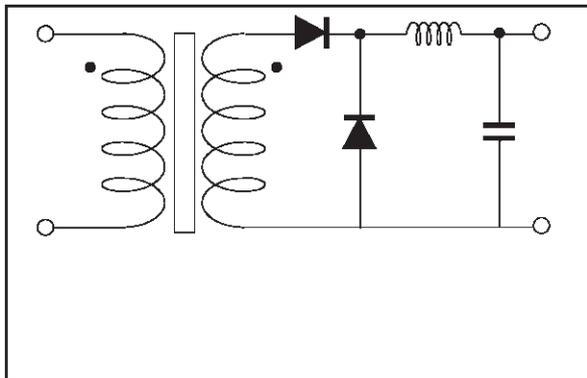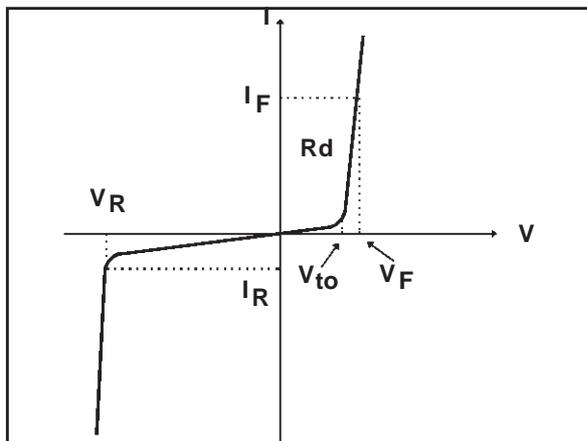**Fig. C :** DEMAGNETIZING DIODE.

Fig. D : RECTIFIER DIODE.

STATIC & DYNAMIC CHARACTERISTICS . POWER LOSSES .

Fig. E: STATIC CHARACTERISTICS

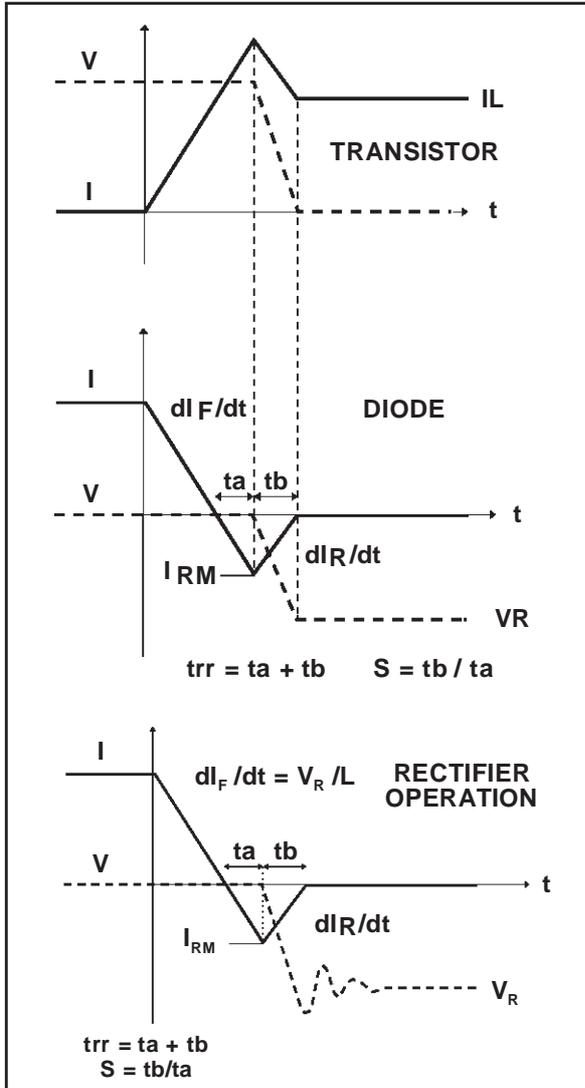**Conduction** losses :

$P1 = V_{to} . I_{F(AV)} + R_d . I_F^2{}_{(RMS)}$

Max values at 125°C, suitable for Ipeak < 3.IF(av)

Reverse losses :

$P2 = V_R . I_R . (1 - \delta)$

APPLICATION DATA (Cont'd)

Fig. F: TURN-OFF CHARACTERISTICS

Turn-on losses :
(in the transistor, due to the diode)

$$P5 = \frac{V_R \times I_{RM}{}^2 \times (3 + 2 \times S) \times F}{6 \, x \, dI_F/dt}$$
$$+ \frac{V_R \times I_{RM} \times I_L \times (S + 2) \times F}{2 \, x \, dI_F/dt}$$
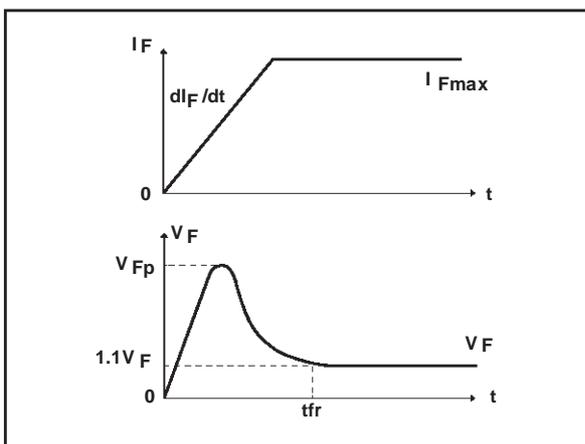
Turn-off losses (in the diode) :

$$P3 = \frac{V_R \times I_{RM}{}^2 \times S \times F}{6 \, x \, dI_F/dt}$$

Turn-off losses :
(with non negligible serial inductance)

$$P3' = \frac{V_R \times I_{RM}{}^2 \times S \times F}{6 \, x \, dI_F/dt} +$$
$$\frac{L \times I_{RM}{}^2 \times F}{2}$$

P3, P3' and P5 are suitable for power MOSFET and IGBT

Fig. G: TURN-ON CHARACTERISTICS

Turn-on losses :
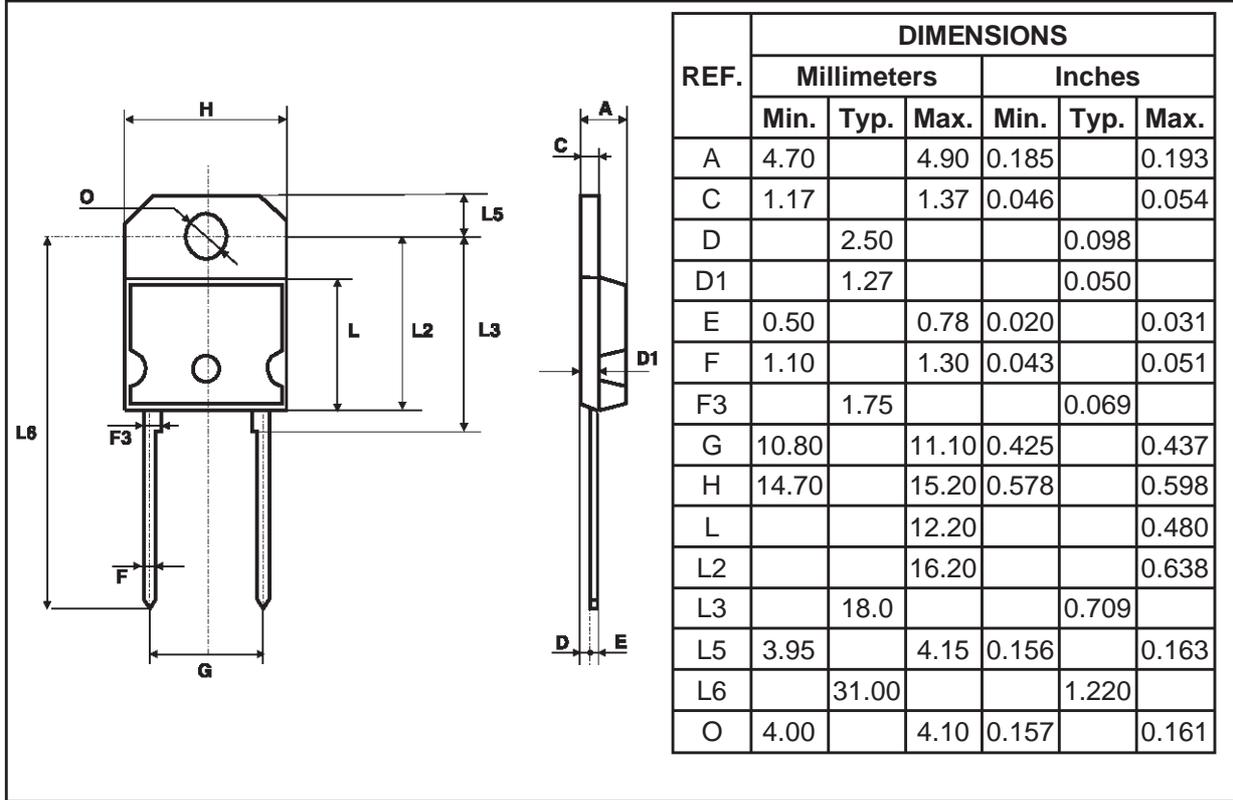
P4 = 0.4 (V_{FP} - V_F) . I_{Fmax} . t_{fr} . F

PACKAGE MECHANICAL DATA
ISOTOP

REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	11.80	12.20	0.465	0.480
A1	8.90	9.10	0.350	0.358
B	7.8	8.20	0.307	0.323
C	0.75	0.85	0.030	0.033
C2	1.95	2.05	0.077	0.081
D	37.80	38.20	1.488	1.504
D1	31.50	31.70	1.240	1.248
E	25.15	25.50	0.990	1.004
E1	23.85	24.15	0.939	0.951
E2	24.80 typ.		0.976 typ.	
G	14.90	15.10	0.587	0.594
G1	12.60	12.80	0.496	0.504
G2	3.50	4.30	0.138	0.169
F	4.10	4.30	0.161	0.169
F1	4.60	5.00	0.181	0.197
P	4.00	4.30	0.157	0.69
P1	4.00	4.40	0.157	0.173
S	30.10	30.30	1.185	1.193

■

PACKAGE MECHANICAL DATA
SOD93

REF.	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.70		4.90	0.185		0.193
C	1.17		1.37	0.046		0.054
D		2.50			0.098	
D1		1.27			0.050	
E	0.50		0.78	0.020		0.031
F	1.10		1.30	0.043		0.051
F3		1.75			0.069	
G	10.80		11.10	0.425		0.437
H	14.70		15.20	0.578		0.598
L			12.20			0.480
L2			16.20			0.638
L3		18.0			0.709	
L5	3.95		4.15	0.156		0.163
L6		31.00			1.220	
O	4.00		4.10	0.157		0.161

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STTA5012TV1	STTA5012TV1	ISOTOP	27g. without screws	10	Tube
STTA5012TV2	STTA5012TV2	ISOTOP		10	Tube
STTA2512P	STTA2512P	SOD93	3.79g.	30	Tube

- Cooling method: by conduction (C)
- ISOTOP recommended torque value: 1.3 N.m. (MAX 1.5 N.m.) for the 6 x M4 screws. (2 x M4 screws recommended for mounting the package on the heatsink and the 4 screws for terminals).
- ISOTOP: the screws supplied with the package are suitable for mounting on a board with a thickness of 0.6 mm min and 2.2 mm max.
- Epoxy meets UL94, V0